FORM PTO-1619A			U.S. DEPARTMENT OF COMMERCE	
(Rev. 6-99)		/# 18 	Patent and Trademark Office	
To the Honorable Commissic	10203507	76 al document	or copy thereaf.	
1. Submission Type X New Resubmission (Non-Recordation) Document ID #	18-02	Name of Conveying Part HONG, JI SUK CHOI, CHUL CHAN	ty(ies):	
Correction of PTO Error Reel # Frame # Corrective Document Reel # Frame #	Ac	lditional Name(s) of conveying pa	artv(s) attached? Tye XNo	
			any(e) and only [1] in [A] ito	
Name and Address of Receiving Party(ie	s): 4.	Nature of conveyance:	_	
Name: HYNIX SEMICONDUCTOR IN	<u>c.</u>	X Assignment	Merger	
Street Address: San 136-1 Ami-Ri, B Kyoungki-Do City: Ich'on State/Country: Korea 2 Additional name(s) & address(es)	Zip:	Security Agreement Other: xecution Date: 02272002	Change of Name	
5. Application number(s) or patent num				
If this document is being filed togeth X the first execution date of the application is: A. Patent Application No.(s)	oation is: 02272002 03182002	on, Patent No.(s) 03/21/2002 GGEBREGI 00000	0009 10098524 40.00 GP	
6 Name and address of party to whom concerning this matter should be ma CUSTOMER NUMBER or JACOBSON, PRICE, HOLMAN 8 400 Seventh Street, N Washington, DC 200 Tel. 202-638-6660 Attorney Docket No. P67503US0	iled: 00136 & STERN, PLLC J.W. 004	=	and patents 1 \$ 40.00 losed fees are authorized	
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Statement and Signature. To the best of my knowledge and is a true copy of the original docu		ormation is true and corre	ct and any attached copy	
Yoon S. Ham/45,307	_ This	illm	March 18, 2002	
Name of Person Signing/Reg. No. Signature Total number of pages excluding cover sheet: -1-				

03-28-2002

JPH&S 103-11/99

Commissioner of Patents & Trac

PATENT REEL: 012714 FRAME: 0811

Washington, D.C. 20231

UNITED STATES OF AMERICA - ASSIGNMENT

(1-5)	Insert Name(s) of Inventors	(1)	Ji Suk HONG			
		(2)	Chul Chan CHOI	******		
		(2)				
				and		
		(5)	In consideration of the sum of one dollar (\$1.00), and other good and valuable considerati			
	•		paid to each of the undersigned, the receipt and sufficiency of which are hereby acknowledged,			
			undersigned hereby assigns, transfers and sets over to			
(6)	Insert Name of Assignee	(6)	Hynix Semiconductor Inc.			
<i>(7)</i>	Insert Address of Assignee	(7)	of San 136-1, Ami-ri, Bubal-eub, Ich'on, Kyoungki-do, Ko	rea		
(8)	Insert Legal Entity and State	or (8)	a Corporation of Republic of Korea			
	Country (e.g., a corporation		(hereinafter designated as the Assignee) the entire right, title and interest for the United States	, its		
(0)	citizen of Japan) territories, dependencies and possessions, in the invention known as Insert Identification of Invention, (a) METHOD FOR FARRICATING SEMICONDITION MEMORY DEVICE					
(9)	such as Title, Case Number		METHOD FOR FABRICATING SEMICONDUCTOR MEMORY DEVICE			
	Foreign Application Number		for which the undersigned has (have) executed an application for patent in the United States	of		
(10)		of (10)	Said application having been executed/filed on March 18, 2002 (and assig			
• •	Application, or filing date as Serial No., if known	na · ·	Serial No. New Application)			
			all papers necessary in connection with this application and any continuing or divisional applicati nection with such applications as the Assignee may deem necessary or expedient.	ons		
3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims provisions of the International Union for Protection of Industrial Property or similar agreements. 4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the 5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue any and all Letters Patents United States resulting from this application or any continuing or divisional applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute any agreement in conflict herewith. 6) Assignor hereby further assigns to Assignee all claims and causes of action for infringement of the patent rights assigned herein, including right to sue for, and collect damages for, any and all acts of past and future infringement. 7) The undersigned hereby grant(s) the law firm of Jacobson Holman PLLC, 400 Seventh Street, N.W., Washington, D.C.						
20004, the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.						
i	In witness whereof, executed b	y the under	rsigned on the date(s) opposite the undersigned name(s).			
Date	february 21, 2002	Name of In	ventor Ji Suk HONG (SEA	AL)		
Date	2003 2 20	Name of In	Chul Chan CUOT	۱L)		
			typed name signature			
Date		Name of In	typed name signature (SEA	(L)		
Date		Name of In	· · · · · · · · · · · · · · · · · · ·	AL)		
Date		1101110 01 111	typed name signature			
Date		Name of In	ventor (SE/	AL)		
typed name signature This assignment should preferably be signed before a United States Consul if signed abroad, or a Notary Public if domestically signed. If not, then the execution by the inventor(s) should be witnessed by at least two witnesses who sign here:						
Additional Inventor's names and Witness Lim journ						
OI	a separate sheet.		Witness J. Y. Kim			

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JACOBSON HOLMAN

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THE JENIFER BUILDING
400 SEVENTH STREET, N.W.
WASHINGTON, D.C. 20004

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PATENT REEL: 012714 FRAME: 0812